

Applicant: Johnny Zhong et al.  
 Serial No.: 10/698,581  
 Filing Date: October 31, 2003  
 For: THIN FILM INTERLEAVER

Confirmation No.: 1109  
 Att'y Docket No.: 15436.132.1  
 Group: ~~2874~~ 3749



# INFORMATION DISCLOSURE CITATIONS MADE BY APPLICANT

## U.S. Patent Documents

Examiner Initial*	Document Number	Issue Date	Name
<u>AB</u> 1	6,421,177	07/16/2002	Leyva et al.
<u>AB</u> 2	6,256,433	07/03/2001	Luo et al.

## Foreign Patent Documents

Examiner Initial*	Document Number	Publication Date	Country or Patent Office	Translation
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## Other Documents

(including author, title, pertinent pages, etc.)

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<u>AB</u> 3	Nick Herring, <i>The E-Tek Interleaver with Lowest Dispersion</i> , BFi OPTiLAS, June 20, 2000.
<u>AB</u> 4	Stephane Bourgeois, <i>Fused-Fiber Developments: Offer Passive Foundation for Optical Slicing</i> , Lightwave Special Report, March 4, 2000.
<u>AB</u> 5	Joseph C. Chon et al., <i>Ultra-high Capacity and High Speed DWDM Optical Devices for Telecom and Datacom Application</i> , Proceedings of SPIE, Vol. 4581, 2001, pp. 13-20.
<u>AB</u> 6	Wavesplitter Lighting the Internet on Fiber Catalog, <i>Creating Unique Advantages Together</i> , WaveProcessor F <sup>3</sup> T Interleaver, February 2002.

Examiner:

Date Considered:

ALFRED BASHCHAS

3/15/05

\*EXAMINER: Initial reference considered, whether or not citation is in conformance with MPEP 609, draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.